

## Bill of Materials

## TI DESIGNS

TIPD147: Noise Measurement Post-Amp

|   | Quantity | Designator | Value  | Description                 | Manufacturer      | Manufacturer PN | DigiKeyPartNumber |
|---|----------|------------|--------|-----------------------------|-------------------|-----------------|-------------------|
| 1 | 1        | U2         | OPA211 | 36V, Low Noise/Power Op Amp | Texas Instruments | OPA211AIDR      | 296-22634-1-ND    |
| 1 | 1        | U2         | OPA209 | 36V, Low Noise/Power Op Amp | Texas Instruments | OPA209AID       | 296-28030-5-ND    |
| 1 | 1        | U2         | OPA847 | 5V, Ultra-Low Noise Op Amp  | Texas Instruments | OPA847ID        | 296-15171-5-ND    |

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